

Sunday 2004 Tutorial Program

	General Reliability	ESD	High K Dielectric	NBTI	
AM1	101. Introduction to Reliability V. Reddy TI	121. ESD & Latchup in Advanced Technologies S. Voldman IBM	131. Mat. Prop. And Local Phen. In High K Dielectrics Glen Wilk ASM America	141. NBTI: Physics, Materials & Process Issues D. Schroder ASU	
AM2			132. Interfacial Reaction & Stability of High K Dielectrics & Metals R. Wallace U.T. Dallas	142. Device and Circuit Issues A. Krishnam TI	
	Design Practices			SER	Vendors
PM1	111. Product Rel. Challenges for VLSI Tech. R. Bolam, IBM	122. ESD Protection Design in CMOS T. Maloney Intel	133. Deposition & Defect Characterization of High K Mat J. Conley, Sharp	151. Intro to SER and Testing Challenges R. Velazco TIMA	160. Vendor Presentations
PM2	112. Effect of Rel. Mech. On VLSI Circuit Function W. Ellis, IBM	123. ESD Testing: HBM to vf-TLP H. Gieser Fraunhofer IZM	134. Defect Transport of High K Dielectrics Ed Cartier IBM	152. Software Approaches to Mitigating SERs F. Faure TIMA	
				153. Eval. SERs in FPGAs M. Wirthlin BYU	